



Integrated
Circuit
Systems, Inc.

PRELIMINARY

ICS839893I

Low SKEW, 1-TO-13

LVC MOS/LVTTL BUFFER DIVIDER

GENERAL DESCRIPTION

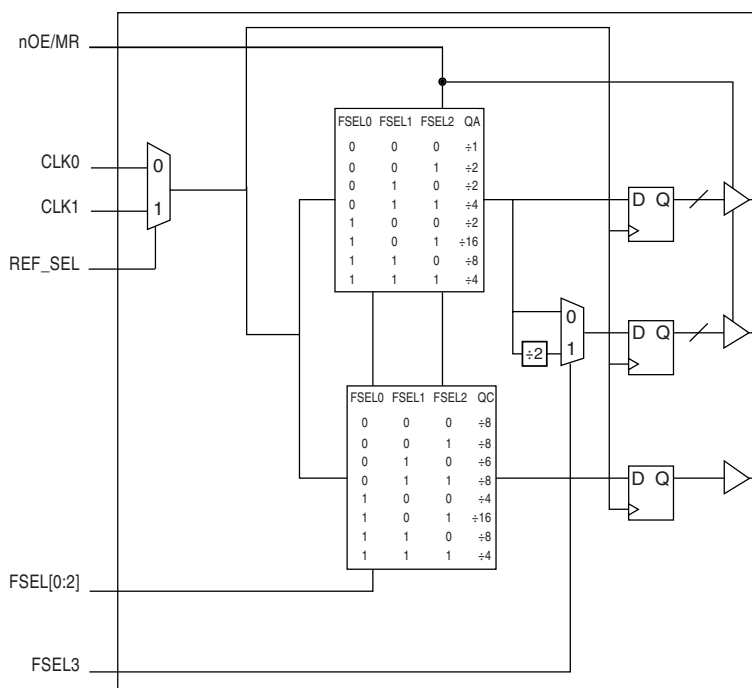


The ICS839893I is a high-performance one to thirteen LVC MOS/LVTTL buffer/divider and is a member of the HiPerClockS™ family of High Performance Clock Solutions from ICS. The device has two selectable LVC MOS/LVTTL clock inputs and it generates 13 new LVC MOS/LVTTL clock outputs. The first bank of six outputs offers divide-by-1, 2, 4, 8 or 16. The second bank of six outputs can be configured to the same divide ratio as the first bank, or with an additional divide-by-two. The first two banks can be placed into a high-impedance output state with the assertion of a LOW on the nOE/MR input. One additional output can be configured to divide-by-4, 6, 8 or 16. This device is functional with full 3.3-V or full 2.5-V supplies.

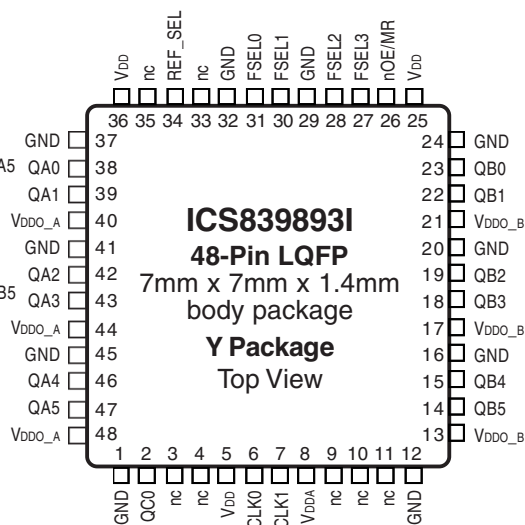
FEATURES

- 13 LVC MOS/LVTTL outputs: 3 banks (6, 6, 1 outputs per bank respectively)
- Selectable CLK0 or CLK1 LVC MOS/LVTTL clock inputs
- CLK0, CLK1 supports the following input types: LVC MOS, LVTTL
- Maximum output frequency: 250MHz
- Output skew: TBD, within bank
- Full 3.3V or 2.5V operating supply
- -40°C to 85°C ambient operating temperature

SIMPLIFIED BLOCK DIAGRAM



PIN ASSIGNMENT



The Preliminary Information presented herein represents a product in prototyping or pre-production. The noted characteristics are based on initial product characterization. Integrated Circuit Systems, Incorporated (ICS) reserves the right to change any circuitry or specifications without notice.



TABLE 1. PIN DESCRIPTIONS

Number	Name	Type		Description
1, 12, 16, 20, 24, 29, 32, 37, 41, 45	GND	Power		Supply ground.
2	QC0	Output		Bank C output. LVCMOS / LVTTL interface levels.
3, 4, 9, 10, 11, 33, 35	nc	Unused		No connect.
5, 25, 36	V _{DD}	Power		Core supply pins.
6, 7	CLK0, CLK1	Input	Pulldown	LVCMOS / LVTTL clock inputs.
8	V _{DDA}	Power		Analog supply pin for bias circuitry.
13, 17, 21	V _{DDO_B}	Power		Output supply pins for Bank B.
14, 15, 18, 19, 22, 23	QB5, QB4 QB3, QB2 QB1, QB0	Output		Bank B outputs. LVCMOS / LVTTL interface levels.
26	nOE/MR	Input	Pulldown	Active High Master Reset. Active Low Output Enable. When logic LOW, the internal dividers and the outputs are enabled. When logic HIGH, the internal dividers are reset and the outputs are tri-stated (HiZ). LVCMOS / LVTTL interface levels.
27, 28, 30, 31	FSEL3, FSEL2, FSEL1, FSEL0	Input	Pulldown	Clock frequency selection and configuration of clock divider modes. LVCMOS / LVTTL interface levels.
34	REF_SEL	Input	Pulldown	Selects the primary reference clock. When LOW, selects CLK0 as the primary clock source. When HIGH, selects CLK1 as the primary clock source. LVCMOS / LVTTL interface levels.
38, 39, 42, 43, 46, 47	QA0, QA1, QA2, QA3, QA4, QA5	Output		Bank A outputs. LVCMOS / LVTTL interface levels.
40, 44, 48	V _{DDO_A}	Power		Output supply pins for Bank A.

NOTE: *Pulldown* refers to internal input resistors. See Table 2, Pin Characteristics, for typical values.

TABLE 2. PIN CHARACTERISTICS

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
C _{IN}	Input Capacitance			4		pF
R _{PULLDOWN}	Input Pulldown Resistor			51		kΩ
C _{PD}	Power Dissipation Capacitance (per output)	V _{DD} = V _{DDA} = V _{DDO_x} = 3.465V		9		pF
		V _{DD} = V _{DDA} = V _{DDO_x} = 2.625V		9		pF
R _{OUT}	Output Impedance			14		Ω



Integrated
Circuit
Systems, Inc.

PRELIMINARY

ICS839893I
Low SKEW, 1-TO-13
LVCMOS/LVTTL BUFFER DIVIDER

TABLE 3. CLOCK FREQUENCY FUNCTION TABLE

Inputs				fREF Range (MHz)	Outputs		
FSEL0	FSEL1	FSEL2	FSEL3		QA _x	QB _x	QC0
					fQA _x (MHz)	fQB _x (MHz)	fQC0 (MHz)
0	0	0	0	15 - 250	fREF ÷ 1	fREF ÷ 1	fREF ÷ 8
0	0	0	1			fREF ÷ 2	
0	0	1	0	15 - 250	fREF ÷ 2	fREF ÷ 2	fREF ÷ 8
0	0	1	1			fREF ÷ 4	
0	1	0	0	15 - 250	fREF ÷ 2	fREF ÷ 2	fREF ÷ 6
0	1	0	1			fREF ÷ 4	
0	1	1	0	15 - 250	fREF ÷ 4	fREF ÷ 4	fREF ÷ 8
0	1	1	1			fREF ÷ 8	
1	0	0	0	15 - 250	fREF ÷ 2	fREF ÷ 2	fREF ÷ 4
1	0	0	1			fREF ÷ 4	
1	0	1	0	15 - 250	fREF ÷ 16	fREF ÷ 16	fREF ÷ 16
1	0	1	1			fREF ÷ 32	
1	1	0	0	15 - 250	fREF ÷ 8	fREF ÷ 8	fREF ÷ 8
1	1	0	1			fREF ÷ 16	
1	1	1	0	15 - 250	fREF ÷ 4	fREF ÷ 4	fREF ÷ 4
1	1	1	1			fREF ÷ 8	



ABSOLUTE MAXIMUM RATINGS

Supply Voltage, V_{DD}	4.6V
Inputs, V_I	-0.5V to $V_{DD} + 0.5V$
Outputs, V_O	-0.5V to $V_{DD} + 0.5V$
Package Thermal Impedance, θ_{JA}	47.9°C/W (0 lfpm)
Storage Temperature, T_{STG}	-65°C to 150°C

NOTE: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These ratings are stress specifications only. Functional operation of product at these conditions or any conditions beyond those listed in the *DC Characteristics* or *AC Characteristics* is not implied. Exposure to absolute maximum rating conditions for extended periods may affect product reliability.

TABLE 4A. POWER SUPPLY DC CHARACTERISTICS, $V_{DD} = V_{DDA} = V_{DDO_A} = V_{DDO_B} = 3.3V \pm 5\%$, $T_A = -40^\circ\text{C}$ TO 85°C

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V_{DD}	Core Supply Voltage		3.135	3.3	3.465	V
V_{DDA}	Analog Supply Voltage		3.135	3.3	3.465	V
V_{DDO_A} , V_{DDO_B}	Output Supply Voltage		3.135	3.3	3.465	V
I_{DD}	Power Supply Current			115		mA
I_{DDA}	Analog Supply Current			7		mA
I_{DDO_A} , I_{DDO_B}	Output Supply Current			15		mA

TABLE 4B. POWER SUPPLY DC CHARACTERISTICS, $V_{DD} = V_{DDA} = V_{DDO_A} = V_{DDO_B} = 2.5V \pm 5\%$, $T_A = -40^\circ\text{C}$ TO 85°C

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V_{DD}	Core Supply Voltage		2.375	2.5	2.625	V
V_{DDA}	Analog Supply Voltage		2.375	2.5	2.625	V
V_{DDO_A} , V_{DDO_B}	Output Supply Voltage		3.135	3.3	3.465	V
I_{DD}	Power Supply Current			110		mA
I_{DDA}	Analog Supply Current			7		mA
I_{DDO_A} , I_{DDO_B}	Output Supply Current			14		mA



Integrated
Circuit
Systems, Inc.

PRELIMINARY

ICS839893I
Low SKEW, 1-TO-13
LVCMOS/LVTTL BUFFER DIVIDER

TABLE 4C. LVCMOS/LVTTL DC CHARACTERISTICS, $V_{DD} = V_{DDA} = V_{DDO_A} = V_{DDO_B} = 3.3V \pm 5\%$, $T_A = -40^\circ\text{C}$ TO 85°C

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V_{IH}	Input High Voltage	$V_{DD} = 3.3V$	2		$V_{DD} + 0.3$	V
V_{IL}	Input Low Voltage	$V_{DD} = 3.3V$	-0.3		0.8	V
I_{IH}	Input High Current CLK0, CLK1, nOE/MR, REF_SEL FSEL0:FSEL3	$V_{DD} = V_{IN} = 3.465V$			200	μA
I_{IL}	Input Low Current CLK0, CLK1, nOE/MR, REF_SEL FSEL0:FSEL3	$V_{DD} = 3.465V, V_{IN} = 0V$	-5			μA
V_{OH}	Output High Voltage; NOTE 1	$I_{OH} = -24\text{mA}$	2.4			V
V_{OL}	Output Low Voltage; NOTE 1	$I_{OL} = 24\text{mA}$			0.55	V
		$I_{OL} = 12\text{mA}$			0.30	V

Note 1: Outputs terminated with 50Ω to $V_{DDO_x}/2$. See Parameter Measurement Information, 3.3V Output Load Test Circuit diagram.

TABLE 4D. LVCMOS/LVTTL DC CHARACTERISTICS, $V_{DD} = V_{DDA} = V_{DDO_A} = V_{DDO_B} = 2.5V \pm 5\%$, $T_A = -40^\circ\text{C}$ TO 85°C

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V_{IH}	Input High Voltage		1.7		$V_{DD} + 0.3$	V
V_{IL}	Input Low Voltage		-0.3		0.7	V
I_{IH}	Input High Current CLK0, CLK1, nOE/MR, REF_SEL FSEL0:FSEL3	$V_{DD} = V_{IN} = 2.625V$			200	μA
I_{IL}	Input Low Current CLK0, CLK1, nOE/MR, REF_SEL FSEL0:FSEL3	$V_{DD} = 2.625V, V_{IN} = 0V$	-5			μA
V_{OH}	Output High Voltage; NOTE 1	$I_{OH} = -15\text{mA}$	1.8			V
V_{OL}	Output Low Voltage; NOTE 1	$I_{OL} = 15\text{mA}$			0.6	V

Note 1: Outputs terminated with 50Ω to $V_{DDO_x}/2$. See Parameter Measurement Information, 2.5V Output Load Test Circuit diagram.



Integrated
Circuit
Systems, Inc.

PRELIMINARY

ICS839893I
Low SKEW, 1-TO-13
LVCMOS/LVTTL BUFFER DIVIDER

TABLE 5A. AC CHARACTERISTICS, $V_{DD} = V_{DDA} = V_{DDO_A} = V_{DDO_B} = 3.3V \pm 5\%$, $T_A = -40^\circ\text{C}$ TO 85°C

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
f_{OUT}	Output Frequency		7.5		250	MHz
f_{REF}	Input Frequency		15		125	MHz
t_{PD}	Propagation Delay; NOTE 1			5.5		ps
$t_{sk(o)}$	Output Skew; NOTE 2 within bank			TBD		ps
t_R/t_F	Output Rise/Fall Time	20% to 80%		380		ps
t_{PZL}, t_{PZH}	Output Enable Time; NOTE 2				10	ns
t_{PLZ}, t_{PHZ}	Output Disable Time; NOTE 2				10	ns
odc	Output Duty Cycle			50		%

All parameters measured at f_{MAX} unless noted otherwise.

NOTE 1: Measured from $V_{DD}/2$ of the input to $V_{DD}/2$ output crossing point.

NOTE 2: This parameter is defined in accordance with JEDEC Standard 65.

TABLE 5B. AC CHARACTERISTICS, $V_{DD} = V_{DDA} = V_{DDO_A} = V_{DDO_B} = 2.5V \pm 5\%$, $T_A = -40^\circ\text{C}$ TO 85°C

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
f_{OUT}	Output Frequency		7.5		250	MHz
f_{REF}	Input Frequency		15		125	MHz
t_{PD}	Propagation Delay; NOTE 1			5.6		ps
$t_{sk(o)}$	Output Skew; bank-to-bank			TBD		ps
	NOTE 2 any output to QC			TBD		ps
t_R/t_F	Output Rise/Fall Time	20% to 80%		420		ps
t_{PZL}, t_{PZH}	Output Enable Time; NOTE 2				10	ns
t_{PLZ}, t_{PHZ}	Output Disable Time; NOTE 2				10	ns
odc	Output Duty Cycle			50		%

All parameters measured at f_{MAX} unless noted otherwise.

NOTE 1: Measured from $V_{DD}/2$ of the input to $V_{DD}/2$ output crossing point.

NOTE 2: This parameter is defined in accordance with JEDEC Standard 65.

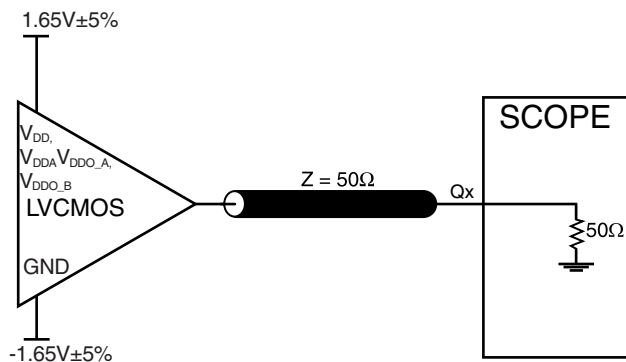


Integrated
Circuit
Systems, Inc.

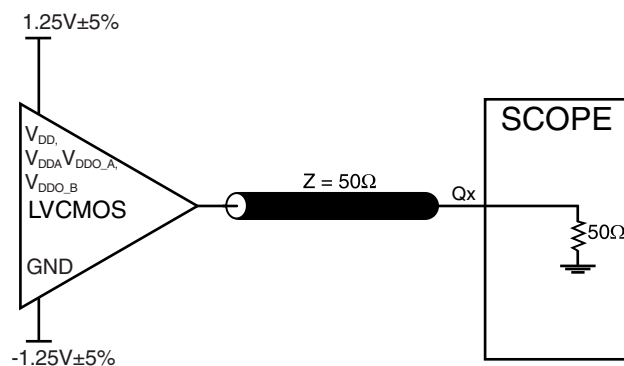
PRELIMINARY

ICS839893I
Low SKEW, 1-TO-13
LVCMOS/LVTTL BUFFER DIVIDER

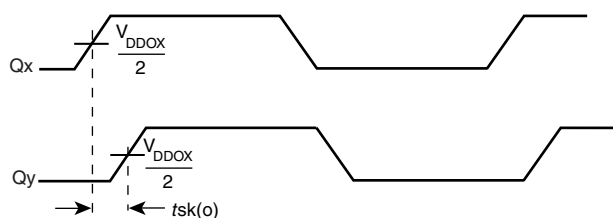
PARAMETER MEASUREMENT INFORMATION



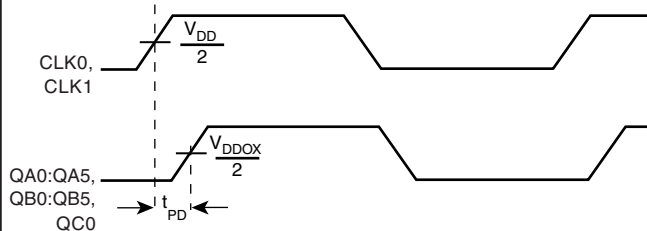
3.3V CORE/3.3V OUTPUT LOAD AC TEST CIRCUIT



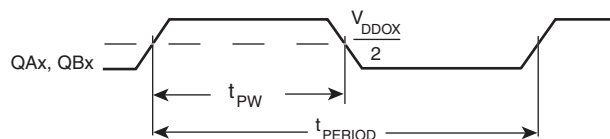
2.5V CORE/2.5V OUTPUT LOAD AC TEST CIRCUIT



OUTPUT SKEW

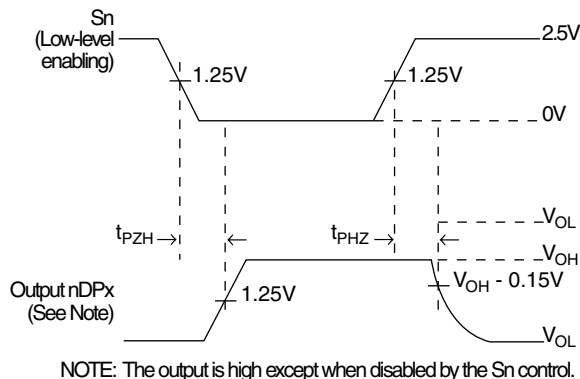


PROPAGATION DELAY



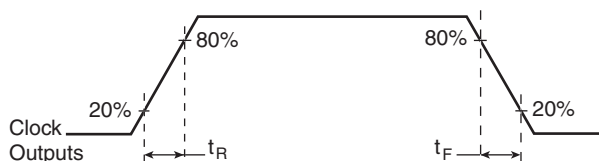
$$odc = \frac{t_{PW}}{t_{PERIOD}} \times 100\%$$

OUTPUT DUTY CYCLE/PULSE WIDTH/PERIOD



NOTE: The output is high except when disabled by the Sn control.

OUTPUT ENABLE/DISABLE TIME



OUTPUT RISE/FALL TIME



RELIABILITY INFORMATION

TABLE 6. θ_{JA} VS. AIR FLOW TABLE FOR 48 LEAD LQFP

θ_{JA} by Velocity (Linear Feet per Minute)			
	0	200	500
Single-Layer PCB, JEDEC Standard Test Boards	67.8°C/W	55.9°C/W	50.1°C/W
Multi-Layer PCB, JEDEC Standard Test Boards	47.9°C/W	42.1°C/W	39.4°C/W

NOTE: Most modern PCB designs use multi-layered boards. The data in the second row pertains to most designs.

TRANSISTOR COUNT

The transistor count for ICS839893I is: 4615



Integrated
Circuit
Systems, Inc.

PRELIMINARY

ICS839893I
Low SKEW, 1-TO-13
LVCMOS/LVTTL BUFFER DIVIDER

PACKAGE OUTLINE - Y SUFFIX FOR 48 LEAD LQFP

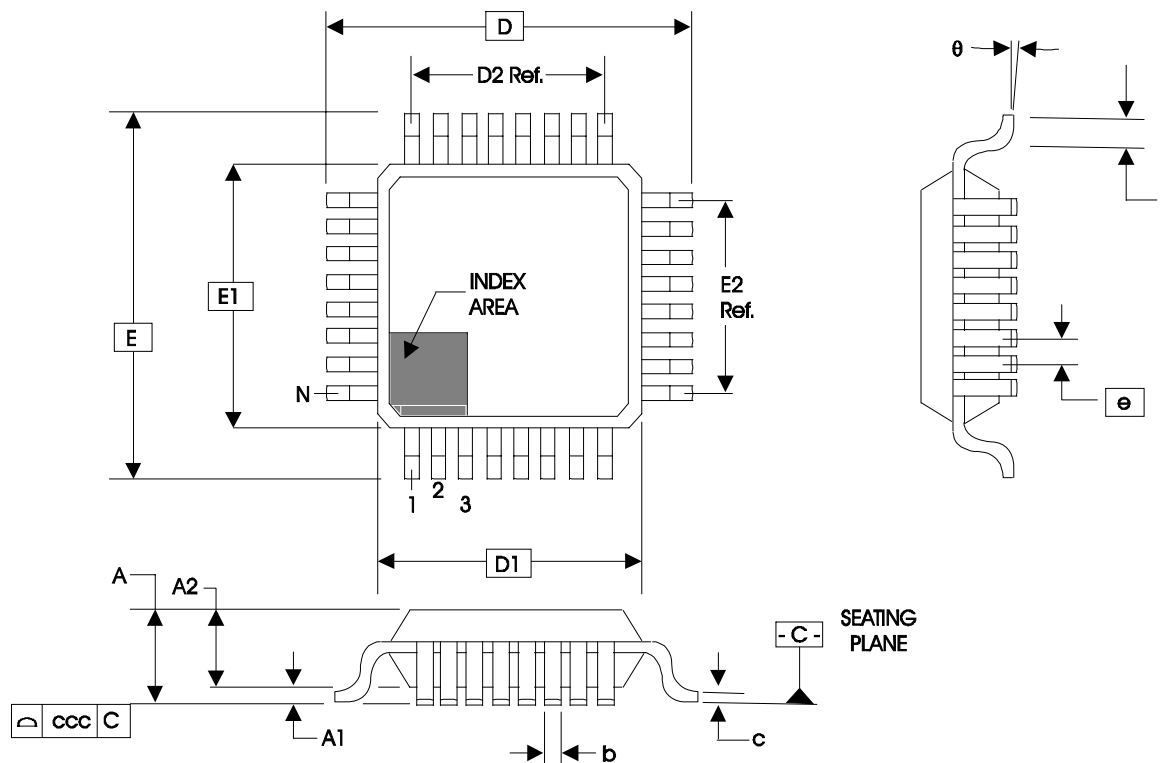


TABLE 7. PACKAGE DIMENSIONS

SYMBOL	JEDEC VARIATION ALL DIMENSIONS IN MILLIMETERS		
	BBC		
	MINIMUM	NOMINAL	MAXIMUM
N	48		
A	--	--	1.60
A1	0.05	--	0.15
A2	1.35	1.40	1.45
b	0.17	0.22	0.27
c	0.09	--	0.20
D	9.00 BASIC		
D1	7.00 BASIC		
D2	5.50 Ref.		
E	9.00 BASIC		
E1	7.00 BASIC		
E2	5.50 Ref.		
e	0.50 BASIC		
L	0.45	0.60	0.75
θ	0°	--	7°
ccc	--	--	0.08

Reference Document: JEDEC Publication 95, MS-026



Integrated
Circuit
Systems, Inc.

PRELIMINARY

ICS839893I
Low SKEW, 1-TO-13
LVCMOS/LVTTL BUFFER DIVIDER

TABLE 8. ORDERING INFORMATION

Part/Order Number	Marking	Package	Shipping Packaging	Temperature
ICS839893AYI	ICS839893AYI	48 Lead LQFP	tray	-40°C to 85°C
ICS839893AYIT	ICS839893AYI	48 Lead LQFP	1000 tape & reel	-40°C to 85°C

The aforementioned trademark, HiPerClockS™ is a trademark of Integrated Circuit Systems, Inc. or its subsidiaries in the United States and/or other countries. While the information presented herein has been checked for both accuracy and reliability, Integrated Circuit Systems, Incorporated (ICS) assumes no responsibility for either its use or for infringement of any patents or other rights of third parties, which would result from its use. No other circuits, patents, or licenses are implied. This product is intended for use in normal commercial and industrial applications. Any other applications such as those requiring high reliability or other extraordinary environmental requirements are not recommended without additional processing by ICS. ICS reserves the right to change any circuitry or specifications without notice. ICS does not authorize or warrant any ICS product for use in life support devices or critical medical instruments.